

2017 Global and Regional NFC Chips Market Research Report Forecasts 2022

<https://marketpublishers.com/r/26AD4BC2EA2EN.html>

Date: June 2017

Pages: 153

Price: US\$ 2,800.00 (Single User License)

ID: 26AD4BC2EA2EN

Abstracts

This report focus on Global and regional market, providing information on major players like manufacturers, suppliers, distributors, traders, customers, investors and etc., major types, major applications from Global and major regions such as Europe, North American, South American, Asia (Excluding China), China and etc. Data type include capacity, production, market share, price, revenue, cost, gross, gross margin, growth rate, consumption, import, export and etc. Industry chain, manufacturing process, cost structure, marketing channel are also analyzed in this report.

This report provides valuable information for companies like manufacturers, suppliers, distributors, traders, customers, investors and individuals who have interests in this industry.

Major companies are as follows:

NXP Semiconductors, Broadcom, Qualcomm, Samsung Semiconductors, ST Microelectronics, TI, Intel (Inside Secure), Sony, Media Tek, Ams AG,

Major types are as follows:

Topaz 512 Chips, MIFARE, DESFire 4k

Major applications are as follows:

For Payment, For Identification, For Connected Homes

Contents

CHAPTER ONE INDUSTRY OVERVIEW

- 1.1 Definition
- 1.2 Specification
- 1.3 Classification
 - 1.3.1 Topaz 512 Chips
 - 1.3.2 MIFARE
 - 1.3.3 DESFire 4k
- 1.4 Application
 - 1.4.1 For Payment
 - 1.4.2 For Identification
 - 1.4.3 For Connected Homes

CHAPTER TWO INDUSTRY CHAIN ANALYSIS

- 2.1 Up Stream Industries Analysis
 - 2.1.1 Raw Material and Suppliers
 - 2.1.2 Equipment and Suppliers
- 2.2 Manufacturing Analysis
 - 2.2.1 Manufacturing Process
 - 2.2.2 Manufacturing Cost Structure
 - 2.2.3 Manufacturing Plants Distribution Analysis
- 2.3 Down Stream Industries Analysis

CHAPTER THREE 2011-2016 GLOBAL MARKET AND MAJOR MANUFACTURERS ANALYSIS

- 3.1 2011-2016 Global Capacity, Production, Capacity Utilization Rate, Price, Revenue, Cost, Gross and Gross Margin Analysis
- 3.2 2011-2016 Major Manufacturers Performance and Market Share

CHAPTER FOUR 2011-2016 REGIONAL MARKET AND MAJOR MANUFACTURERS ANALYSIS

- 4.1 2011-2016 Regional Market Performance and Market Share
- 4.2 Europe Market
 - 4.2.1 2011-2016 Capacity, Production, Capacity Utilization Rate, Price, Revenue,

Cost, Gross, Gross Margin Analysis

4.2.2 2011-2016 Major Manufacturers Performance and Market Share

4.2.3 2011-2016 Supply, Import, Export and Consumption Analysis

4.3 North American Market

4.3.1 2011-2016 Capacity, Production, Capacity Utilization Rate, Price, Revenue, Cost, Gross, Gross Margin Analysis

4.3.2 2011-2016 Major Manufacturers Performance and Market Share

4.3.3 2011-2016 Supply, Import, Export and Consumption Analysis

4.4 South American Market

4.4.1 2011-2016 Capacity, Production, Capacity Utilization Rate, Price, Revenue, Cost, Gross, Gross Margin Analysis

4.4.2 2011-2016 Major Manufacturers Performance and Market Share

4.4.3 2011-2016 Supply, Import, Export and Consumption Analysis

4.5 Asia (Excluding China) Market

4.5.1 2011-2016 Capacity, Production, Capacity Utilization Rate, Price, Revenue, Cost, Gross, Gross Margin Analysis

4.5.2 2011-2016 Major Manufacturers Performance and Market Share

4.5.3 2011-2016 Supply, Import, Export and Consumption Analysis

4.6 China Market

4.6.1 2011-2016 Capacity, Production, Capacity Utilization Rate, Price, Revenue, Cost, Gross, Gross Margin Analysis

4.6.2 2011-2016 Major Manufacturers Performance and Market Share

4.6.3 2011-2016 Supply, Import, Export and Consumption Analysis

4.7 ROW Market

4.7.1 2011-2016 Capacity, Production, Capacity Utilization Rate, Price, Revenue, Cost, Gross, Gross Margin Analysis

4.7.2 2011-2016 Supply, Import, Export and Consumption Analysis

CHAPTER FIVE MAJOR MANUFACTURERS ANALYSIS

5.1 NXP Semiconductors

5.1.1 Company Profile

5.1.2 Product Specification

5.1.3 2011-2016 Global Market Performance

5.1.4 Contact Information

5.2 Broadcom

5.2.1 Company Profile

5.2.2 Product Specification

5.2.3 2011-2016 Global Market Performance

- 5.2.4 Contact Information
- 5.3 Qualcomm
 - 5.3.1 Company Profile
 - 5.3.2 Product Specification
 - 5.3.3 2011-2016 Global Market Performance
 - 5.3.4 Contact Information
- 5.4 Samsung Semiconductors
 - 5.4.1 Company Profile
 - 5.4.2 Product Specification
 - 5.4.3 2011-2016 Global Market Performance
 - 5.4.4 Contact Information
- 5.5 ST Microelectronics
 - 5.5.1 Company Profile
 - 5.5.2 Product Specification
 - 5.5.3 2011-2016 Global Market Performance
 - 5.5.4 Contact Information
- 5.6 TI
 - 5.6.1 Company Profile
 - 5.6.2 Product Specification
 - 5.6.3 2011-2016 Global Market Performance
 - 5.6.4 Contact Information
- 5.7 Intel (Inside Secure)
 - 5.7.1 Company Profile
 - 5.7.2 Product Specification
 - 5.7.3 2011-2016 Global Market Performance
 - 5.7.4 Contact Information
- 5.8 Sony
 - 5.8.1 Company Profile
 - 5.8.2 Product Specification
 - 5.8.3 2011-2016 Global Market Performance
 - 5.8.4 Contact Information
- 5.9 Media Tek
 - 5.9.1 Company Profile
 - 5.9.2 Product Specification
 - 5.9.3 2011-2016 Global Market Performance
 - 5.9.4 Contact Information
- 5.10 Ams AG
 - 5.10.1 Company Profile
 - 5.10.2 Product Specification

5.10.3 2011-2016 Global Market Performance

5.10.4 Contact Information

5.11

5.11.1 Company Profile

5.11.2 Product Specification

5.11.3 2011-2016 Global Market Performance

5.11.4 Contact Information

5.12

5.12.1 Company Profile

5.12.2 Product Specification

5.12.3 2011-2016 Global Market Performance

5.12.4 Contact Information

5.13

5.13.1 Company Profile

5.13.2 Product Specification

5.13.3 2011-2016 Global Market Performance

5.13.4 Contact Information

5.14

5.14.1 Company Profile

5.14.2 Product Specification

5.14.3 2011-2016 Global Market Performance

5.14.4 Contact Information

5.15

5.15.1 Company Profile

5.15.2 Product Specification

5.15.3 2011-2016 Global Market Performance

5.15.4 Contact Information

5.16

5.16.1 Company Profile

5.16.2 Product Specification

5.16.3 2011-2016 Global Market Performance

5.16.4 Contact Information

5.17

5.17.1 Company Profile

5.17.2 Product Specification

5.17.3 2011-2016 Global Market Performance

5.17.4 Contact Information

5.18

5.18.1 Company Profile

- 5.18.2 Product Specification
- 5.18.3 2011-2016 Global Market Performance
- 5.18.4 Contact Information

5.19

- 5.19.1 Company Profile
- 5.19.2 Product Specification
- 5.19.3 2011-2016 Global Market Performance
- 5.19.4 Contact Information

5.20

- 5.20.1 Company Profile
- 5.20.2 Product Specification
- 5.20.3 2011-2016 Global Market Performance
- 5.20.4 Contact Information

CHAPTER SIX MAJOR CLASSIFICATION ANALYSIS

- 6.1 2011-2016 Major Classification Market Share
- 6.2 Topaz 512 Chips
- 6.3 MIFARE
- 6.4 DESFire 4k

CHAPTER SEVEN MAJOR APPLICATION ANALYSIS

- 7.1 2011-2016 Major Application Market Share
- 7.2 For Payment
 - 7.2.1 2011-2016 Consumption Analysis
 - 7.2.2 Major Down Stream Customers Analysis
- 7.3 For Identification
 - 7.3.1 2011-2016 Consumption Analysis
 - 7.3.2 Major Down Stream Customers Analysis
- 7.4 For Connected Homes
 - 7.4.1 2011-2016 Consumption Analysis
 - 7.4.2 Major Down Stream Customers Analysis

CHAPTER EIGHT GLOBAL AND REGIONAL MARKET FORECAST

- 8.1 Global Market Forecast
- 8.2 Regional Market Forecast

CHAPTER NINE MARKETING CHANNEL ANALYSIS

9.1 Marketing Channel Status

9.1.1 Direct Marketing

9.1.2 Indirect Marketing

9.1.3 Trends

9.2 Marketing Strategy

9.2.1 Pricing Strategy

9.2.2 Brand Strategy

9.2.3 Target Client

9.3 Major Distributors Analysis

CHAPTER TEN NEW PROJECT INVESTMENT FEASIBILITY ANALYSIS

10.1 New Project SWOT Analysis

10.2 New Project Investment Feasibility Analysis

CHAPTER ELEVEN CONCLUSIONS

Research Methodology

I would like to order

Product name: 2017 Global and Regional NFC Chips Market Research Report Forecasts 2022

Product link: <https://marketpublishers.com/r/26AD4BC2EA2EN.html>

Price: US\$ 2,800.00 (Single User License / Electronic Delivery)

If you want to order Corporate License or Hard Copy, please, contact our Customer Service:

info@marketpublishers.com

Payment

To pay by Credit Card (Visa, MasterCard, American Express, PayPal), please, click button on product page <https://marketpublishers.com/r/26AD4BC2EA2EN.html>

To pay by Wire Transfer, please, fill in your contact details in the form below:

First name:
Last name:
Email:
Company:
Address:
City:
Zip code:
Country:
Tel:
Fax:
Your message:

****All fields are required**

Customer signature _____

Please, note that by ordering from marketpublishers.com you are agreeing to our Terms & Conditions at <https://marketpublishers.com/docs/terms.html>

To place an order via fax simply print this form, fill in the information below and fax the completed form to +44 20 7900 3970